

3.2x1.6mm SMD CHIP LED LAMP

AP3216YC

YELLOW

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ERP:1203000443

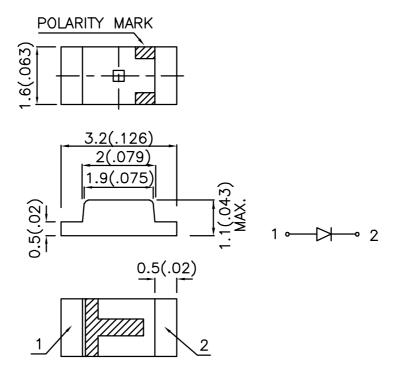
Features

- •3.2mmx1.6mm SMT LED, 1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.
- •RoHS COMPLIANT.

Description

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions



- Notes: 1. All dimensions are in millimeters (inches). 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted. 3. Specifications are subject to change without notice.

SPEC NO: DSAD0984 **REV NO: V.3 DATE: MAR/19/2005** APPROVED: J. Lu **CHECKED: Allen Liu** DRAWN: W.J.ZHU

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) @ 20mA		Viewing Angle
			Min.	Тур.	2 θ 1/2
AP3216YC	YELLOW (GaAsP/GaP)	WATER CLEAR	2.6	8	120°

Note:

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Yellow	590		nm	IF=20mA
λD	Dominant Wavelength	Yellow	588		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Yellow	35		nm	IF=20mA
С	Capacitance	Yellow	20		pF	VF=0V;f=1MHz
VF	Forward Voltage	Yellow	2.1	2.5	V	IF=20mA
IR	Reverse Current	Yellow		10	uA	VR = 5V

Absolute Maximum Ratings at Ta=25°C

Parameter	Yellow	Units	
Power dissipation	105	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	140	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

Note:

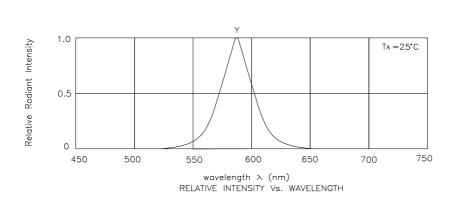
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 $^{1.\,\}theta1/2$ is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

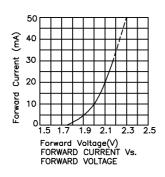
^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

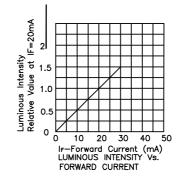
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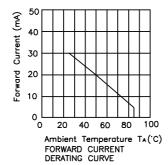


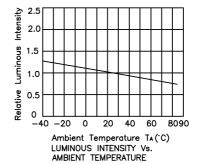
Yellow

AP3216YC









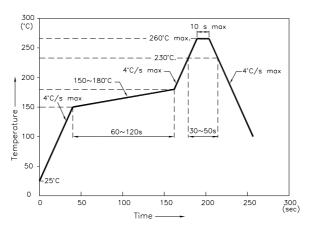
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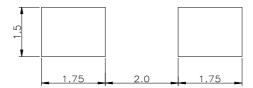
Reflow Soldering Profile For Lead-free SMT Process.



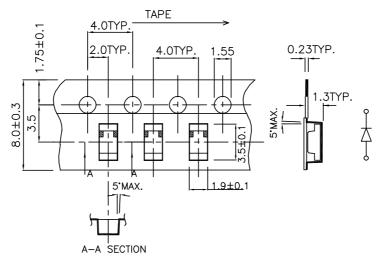
- NOTES:

 1. We recommend the reflow temperature 245°C(+/-5°C). The limited to 260°C and the limited to 260°C. maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units: mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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